KSM5800

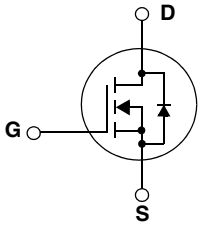
Features

- $R_{DS(on)}$ = 4.6mΩ (Typ.), V_{GS} = 10V, I_D = 80A
- High performance trench technology for extermly low Rdson
- Low gate Charge
- High power and current handing capability
- RoHs Compliant

TO-220

Applications

- Motor/ Body Load Control
- Power Train Management
- Injection Systems
- DC-AC Converters and UPS



MOSFET Maximum Ratings T_C = 25°C unless otherwise noted*

Symbol	Parameter		Ratings	Units
V_{DSS}	Drain-Source Voltage		60	V
V_{GSS}	Gate-Source Voltage		±20	V
I_D	Drain Current	-Continuous (T_C = 25°C)	80	A
		-Continuous (T_C = 100°C)	80*	A
		-Continuous (T_A = 25°C)	14	A
I_{DM}	Drain Current - Pulsed		320	A
E_{AS}	Single Pulsed Avalanche Energy (Note 1)		652	mJ
P_D	Power Dissipation (T_C = 25°C) - Derate above 25°C		242 1.61	W W/°C
T_J, T_{STG}	Operating and Storage Temperature Range		-55 to +175	°C

*Drain current limited by package

Thermal Characteristics

$R_{\theta JC}$	Thermal Resistance , Junction to Case	0.62	°C/W
$R_{\theta JA}$	Thermal Resistance , Junction to Ambient, 1in^2 copper pad area	43	°C/W
$R_{\theta JA}$	Thermal Resistance , Junction to Ambient	62.5	°C/W

Package Marking and Ordering Information

Device Marking	Device	Package	Reel Size	Tape Width	Quantity
KSM580	KSM5800	TO220	--	--	50

Electrical Characteristics T_C= 25°C unless otherwise noted

Symbol	Parameter	Conditions	Min	Typ	Max	Units
Off Characteristics						
B_{VDSS}	Drain-Source Breakdown Voltage	I_D = 250μA, V_{GS} = 0V, T_J =25°C	60	--	--	V
I_{DSS}	Zero Gate Voltage Drain Current	V_{DS} = 48V, V_{GS} = 0V	--	--	1	μA
		V_{DS} = 48V, V_{GS} = 0V, T_J = 150°C	--	--	500	μA
I_{GSS}	Gate-Body Leakage Current, Forward	V_{GS} = ±20V, V_{DS} = 0V	--	--	±100	nA
On Characteristics						
$V_{GS(th)}$	Gate Threshold Voltage	V_{GS} = V_{DS}, I_D = 250μA	1.0	--	2.5	V
$R_{DS(on)}$	Static Drain-Source On Resistance	V_{GS} = 10V , I_D = 80A	--	4.6	6.0	mΩ
		V_{GS} =4.5V , I_D = 80A	--	5.9	7.2	mΩ
		V_{GS} = 5V , I_D = 80A	--	5.6	7.0	mΩ
		V_{GS} =10V, I_D = 80A, T_J = 175°C	--	10.4	12.6	mΩ
Dynamic Characteristics						
C_{iss}	Input Capacitance	V_{DS} = 15V,V_{GS} = 0V, f = 1MHz	--	6890	9160	pF
C_{oss}	Output Capacitance		--	750	1000	pF
C_{rss}	Reverse Transfer Capacitance		--	295	445	pF
R_G	Gate Resistance	V_{GS} = 0.5V, f = 1MHz	--	1.2	--	Ω
$Q_{g(TOT)}$	Total Gate Charge at 10V	V_{GS} = 0V to 10V, V_{DS} = 30V, I_D = 80A, I_g = 1mA	--	112	145	nC
$Q_{g(TH)}$	Total Gate Charge at 5V	V_{GS} = 0V to 5V	--	58	--	nC
$Q_{g(TH)}$	Threshold Gate Charge	V_{GS} = 0V to 1V	--	7.0	--	nC
Q_{gs}	Gate to Source Gate Charge		--	23	--	nC
Q_{gs2}	Gate Charge Threshold to Plateau		--	13	--	nC
Q_{gd}	Gate to Drain “Miller” Charge		--	18	--	nC
Switching Characteristics (V_{GS} = 10V)						
t_{ON}	Turn-On Time	V_{DD} = 30V, I_D = 80A, V_{GS} = 10V, R_{GEN} = 1.5Ω	--	37	85	ns
$t_{d(on)}$	Turn-On Delay Time		--	18	46	ns
t_r	Turn-On Rise Time		--	19	47	ns
$t_{d(off)}$	Turn-Off Delay Time		--	55	120	ns
t_f	Turn-Off Fall Time		--	9	28	ns
t_{OFF}	Turn-Off Time		--	64	138	ns
Drain-Source Diode Characteristics						
V_{SD}	Drain-Source Diode Forward Voltage	V_{GS} = 0V, I_{SD} = 80A	--	--	1.25	V
		V_{GS} = 0V, I_{SD} = 40A	--	--	1.0	V
t_{rr}	Reverse Recovery Time	V_{GS} = 0V, I_{SD} = 60A, dI_F/dt = 100A/μs	--	58	--	ns
Q_{rr}	Reverse Recovery Charge		--	106	--	nC

Notes:
1: L = 1mH, I_{AS} = 36A, V_{DD} = 54V, V_{GS} = 10V, R_G = 25Ω, Starting T_J = 25°C

Typical Performance Characteristics

Figure 1. On-Region Characteristics

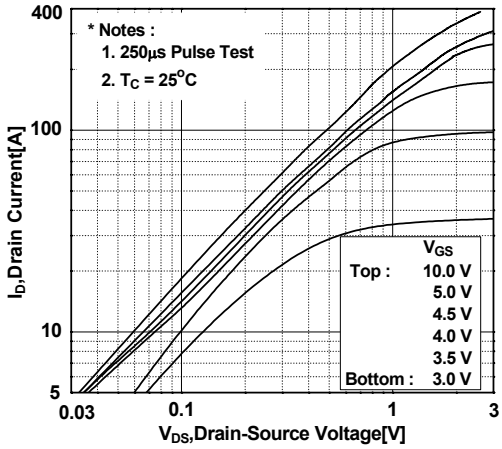


Figure 2. Transfer Characteristics

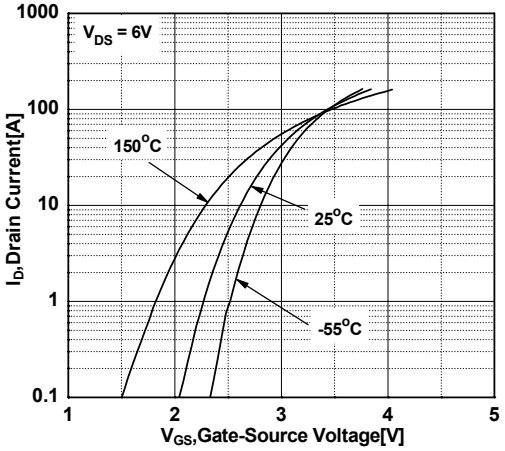


Figure 3. On-Resistance Variation vs. Drain Current and Gate Voltage

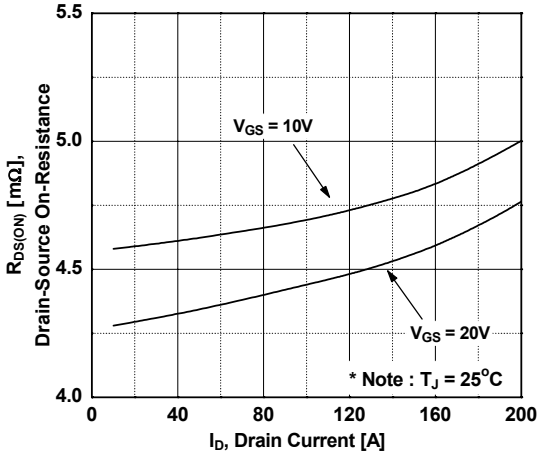


Figure 4. Body Diode Forward Voltage Variation vs. Source Current and Temperatue

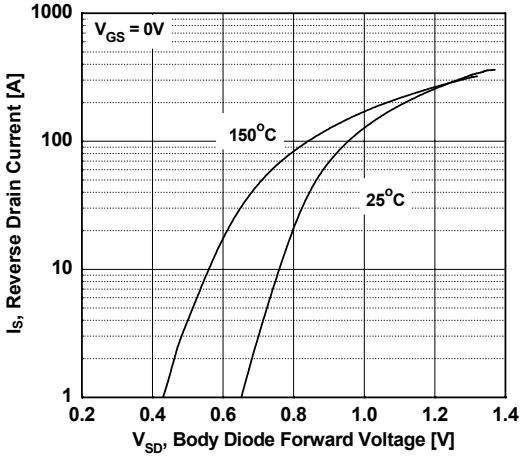


Figure 5. Capacitance Characteristics

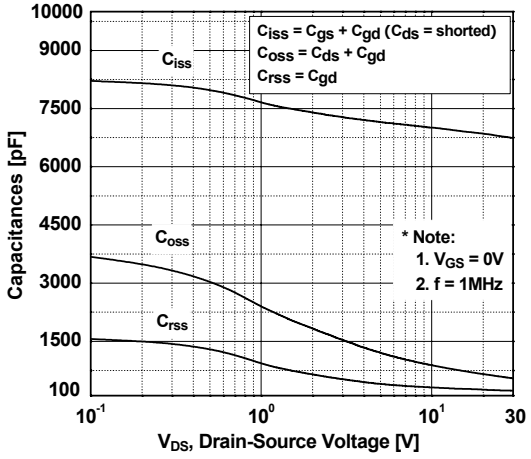
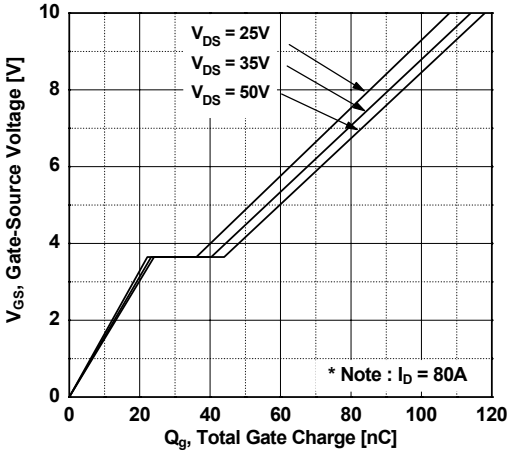


Figure 6. Gate Charge Characteristics



Typical Performance Characteristics (Continued)

Figure 7. Breakdown Voltage Variation vs. Temperature

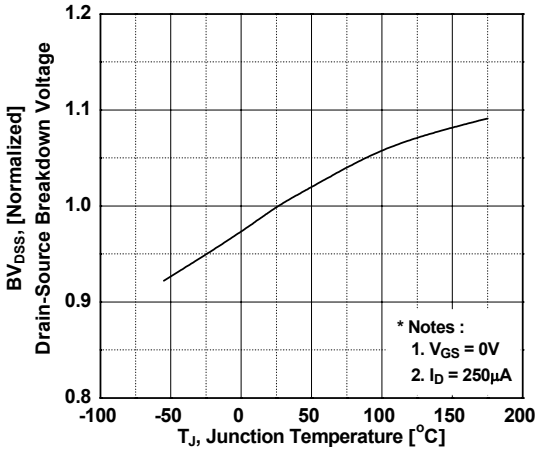


Figure 8. On-Resistance Variation vs. Temperature

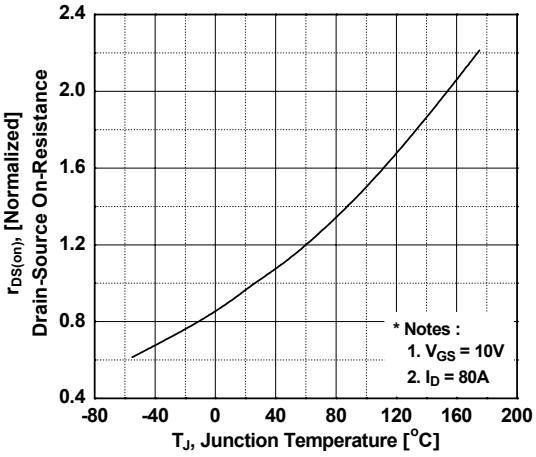


Figure 9. Maximum Safe Operating Area

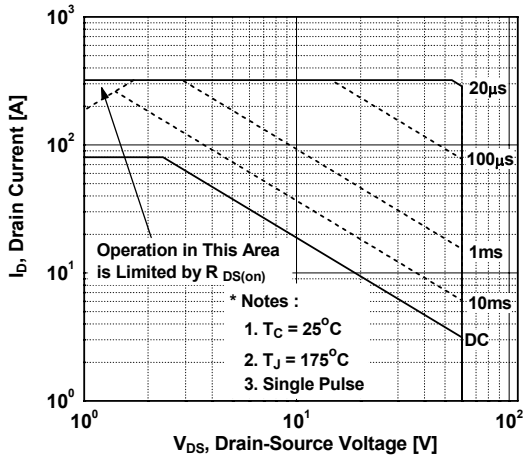


Figure 10. Maximum Drain Current vs. Case Temperature

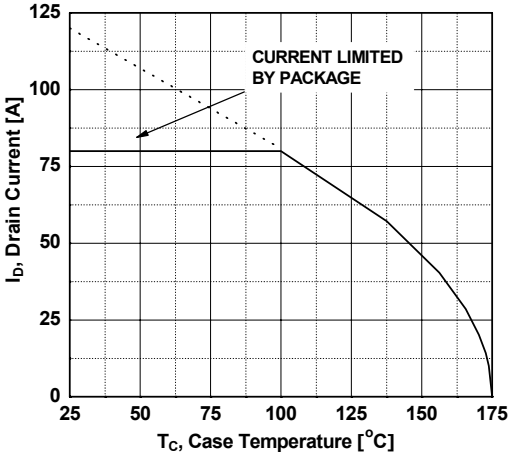
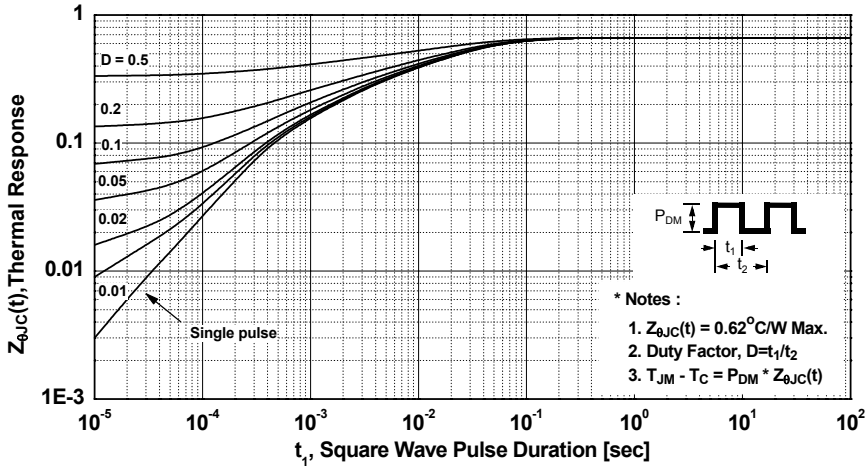
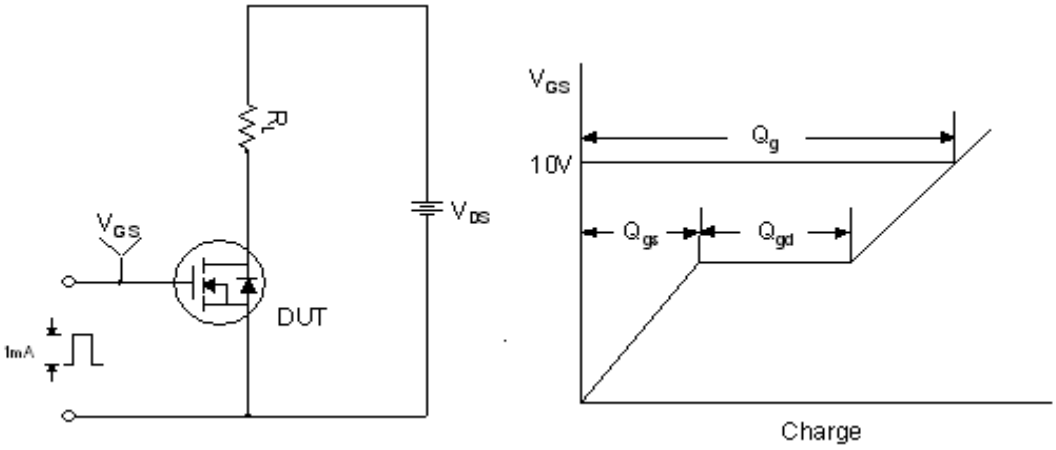


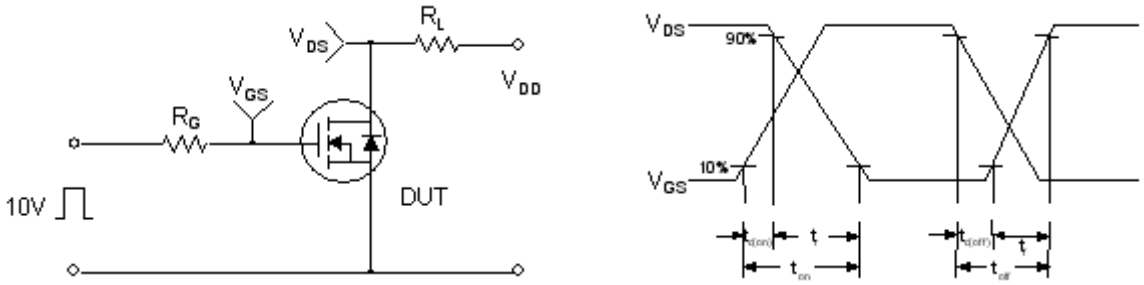
Figure 11. Transient Thermal Response Curve



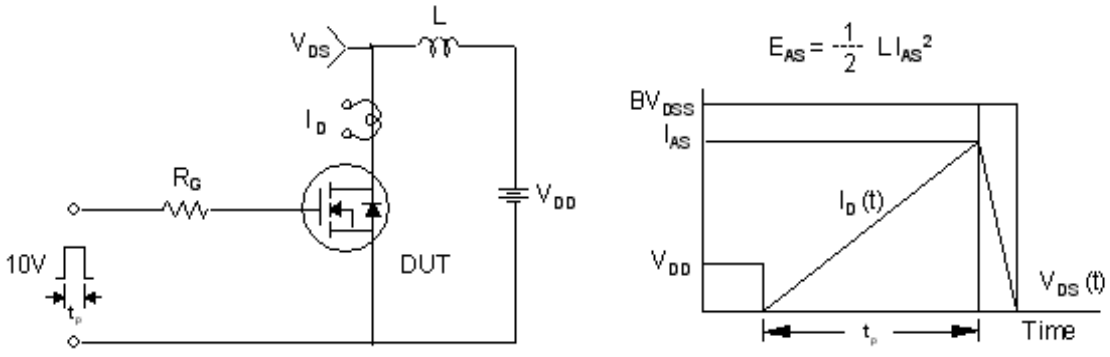
Gate Charge Test Circuit & Waveform



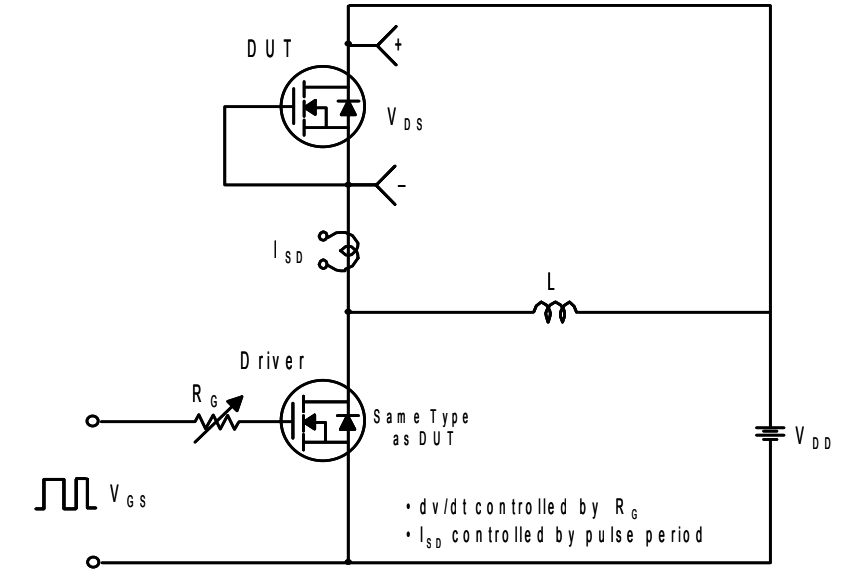
Resistive Switching Test Circuit & Waveforms

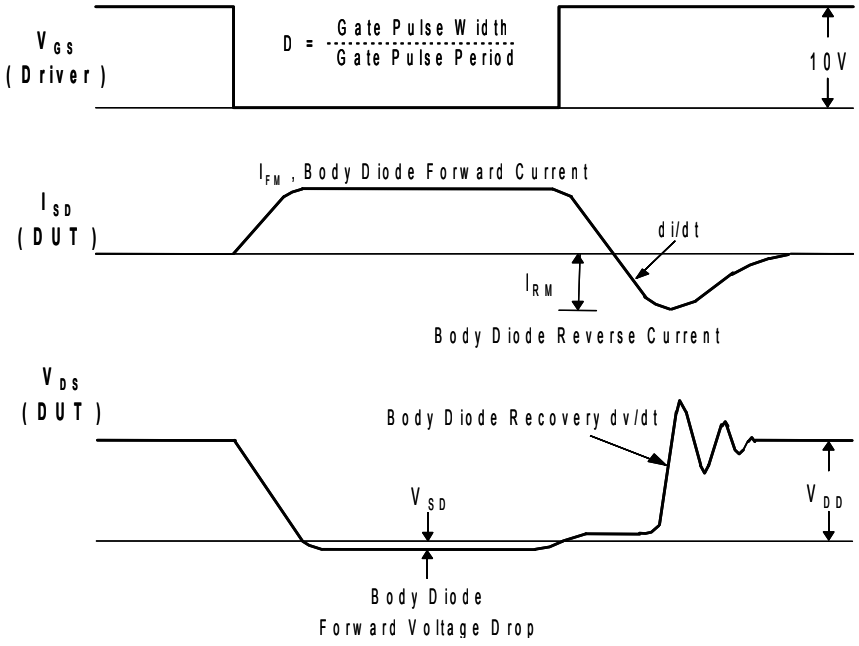


Unclamped Inductive Switching Test Circuit & Waveforms



Peak Diode Recovery dv/dt Test Circuit & Waveforms





Mechanical Dimensions

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